ABBOCIATION CONNECTING ELECTRONICS INDUSTRIES® MALECTRONICS INDUSTRIES®	ckburn, Illinois. A	Il rights reserved untions.	nder both	This docume level parts, t	ent is a declar he declaratio	ration of th n encompa	e substances sses all lowe	within the manufa er level materials f	acturer listed or which the	l item. N manufa	lote: if the cturer has	e item is an ass s engineering r	sembly with lower esponsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information									
Supplier Information														
mpany name* Company unique ID				Unique ID Authority					Respo	Response Date*				
onsemi	semi				2024-05-03									
Contact Name	tact Name Title - Contact				Phone - Contact*				Email	Email - Contact*				
roduct-Env-Stewards Product Enviro Compliance					NA				Produ	Product-Env-Stewards@onsemi.com				
thorized Representative* Title - Representative]	Phone - Representative*				Email	Email - Representative*				
Product-Env-Stewards	o Compliance			NA				Produ	Product-Env-Stewards@onsemi.com					
Requester Item Number Mfr	tem Number	Mfr Item Name			Effective Da	ate Versi	ion	Manufacturing Site		Weigh	t*	UOM	Unit Type	
NCV	√20092DTBR2G R2R IO Dual Am		plifier	fier 20				PH1		21.81		mg	Each	
Manufacturing Proccess Information						1							•	
Terminal Plating / Grid Array Material	Terminal Base	Ferminal Base Alloy		L Rating	Peak Process Body Temper		y Temperatu	ture Max Time at Peak Tem		rature Number of Reflow Cycles		les		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)	Precious metal (e.g. Ag,Au, NiPdAu) (no CU Alloy Sn)		1		260		C	30		seconds 3				
Comments														
evel 1 - maximum time at peak temperature during	soldering is 10-3	0 seconds												
for more information regarding material composit	on please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	toHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.84	mg	Supplier	Silicon (Si)	7440-21-3		0.84	mg
Die Attach	0.31	mg		Epoxy resin	proprietary data		0.031	mg
			Supplier	Silver (Ag)	7440-22-4		0.248	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.031	mg
Lead Frame 10	10.38	mg	Supplier	Zinc (Zn)	7440-66-6		0.0125	mg
			Supplier	Iron (Fe)	7439-89-6		0.2439	mg
			Supplier	Copper (Cu)	7440-50-8		10.1205	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0031	mg
Mold Compound-Black	10.1	mg		Epoxy resin	proprietary data		0.505	mg
			Supplier	Phenolic Resin	Proprietary Data		0.202	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.2525	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0505	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		9.09	mg
Plating	0.11	mg	Supplier	Palladium (Pd)	7440-05-3		0.01	mg
			В	Nickel (Ni)	7440-02-0		0.0989	mg
			Supplier	Gold (Au)	7440-57-5		0.0011	mg
Wire Bond - Au	0.07	mg	Supplier	Gold (Au)	7440-57-5		0.07	mg